

The Electronics Division Hoffman Scholarship Application Form 2025 Essay Topic:

"The Role of Polymer-Derived Ceramics in Shaping Additive Manufacturing for Electronics"

Application Deadline: extended to June 30th

Full Name			
Email Address			
Mailing Address			
Name of Undergraduate Department			
University			
	Total GPA	Science GPA	Total Credits
DO 4 T/O 4 T/4 OT O			
PSAT/SAT/ACT Scores		D	ate of Exam
Extracurricular Activities			
(attach additional sheets if			
necessary)			
Faculty Advisor*			
Address	-		
Telephone	()	E-mail	
Applicant's Signature			Date
Advisor's Signature			D. 1.
Advisor s digriature			Date

Christina Rost Virginia Tech cmrost@vt.edu

Nominations should also be sent to Vicki Evans at vevans@ceramics.org.

^{*} Essay and Recommendation letter must be emailed directly to: